Call for Industry Forum & Business Panel Proposals

Industry Forums & Exhibition Chair
Khaled B. Letaief  Hong Kong University of Science and Technology, Hong Kong

Industry Panel Co-Chairs
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The 2016 IEEE International Conference on Communications (ICC) will be held on 23-27 May 2016 at Kuala Lumpur Convention Center, Malaysia. Themed “Communications for All Things,” this flagship conference of IEEE Communications Society (ComSoc) will feature a comprehensive Technical Program including 13 Symposia and a number of Tutorials and Workshops. IEEE ICC 2016 will also include an attractive Industry Forum & Exhibition Program featuring keynote speakers, business and industry panels, and vendor exhibits.

The Industry Forum and Exhibition (IF&E) Program Committee of IEEE ICC2016 solicits proposals for industry forum & business panel sessions to provide opportunities for the practicing professionals to both share and learn about the latest ideas, trends, and product innovations in the broader communications and networking industries.

Industry forum & business panel sessions are 90-minute moderated discussions on a specific topic of interest which are scheduled between Tuesday-Thursday of the conference (24-26 May 2016).

A submission to include
- A Panel Session Leader with a commitment to arrange the specific topic of interest;
- 3-5 Panel Session Speakers with a commitment to join in under the specific topic.

Panels are an important component of ICC 2016 to bring together industry and researchers from around the world for an interactive discussion among the panel members and the participants on focused topics.

Before submitting a panel proposal, the organizer of a panel is expected to contact all the proposed panel members and get their agreement to serve as a panel member. A list of questions to be discussed in the panel should be made available to all the panel members well ahead of time for them to prepare their response. Each panel typically allows a certain amount of time for each panel member to present their response before an open discussion is opened to the floor.

The panel proposal should include:
- Title for the proposed panel session
- Name, affiliation and email address of the Panel Session Leader
- Short biography of the Panel Leader
- 200-500 word abstract indicating a desired program component and submission track(s)
- Names, affiliations, brief description/short biography of the Panel Speakers Intended to invite

Interested participants should submit proposals to the IF&E Chair Khaled B. Letaief <eekhaled@ee.ust.hk>

Important Dates
- Panel Proposal Deadline: 13 November 2015
- Final Speakers/Program: 1 March 2016
- Presentation Materials Due: 1 April 2016
- Industry Program Dates: 24 – 26 May 2016